PKR 4000B series Direct Converters
Input 36-75 V, Output up to 5 A / 15 W

Key Features
- Industry standard footprint
  47.8 x 28.1 x max height 8.0 mm (1.88 x 1.11 x max
  height 0.32 in.)
- High efficiency, typ. 86 % at 3.3 Vout full load
- 1500 Vdc input to output isolation
- Meets isolation requirements equivalent to basic
  insulation according to IEC/EN/UL 60950
- More than 4.5 million hours predicted MTBF at 40°C
  ambient temperature

General Characteristics
- Over temperature protection
- Over current protection
- Output short-circuit protection
- Soft start
- Remote control
- Output voltage adjust function
- Highly automated manufacturing to ensure highest
  quality
- ISO 9001/14001 certified supplier

Safety Approvals

Design for Environment
Meets requirements in high-
temperature lead-free soldering
processes.

The MacroDens™ PKR 4000B series true component level
on-board DC/DC power modules are intended as distributed
power sources in decentralized – 48 and –60VDC power
systems.

Contents

Ordering Information ......................................................2
General Information ......................................................2
Safety Specification ......................................................3
Absolute Maximum Ratings ......................................................4

Electrical Specification
1.8V, 5A / 9 W PKR 4918B SI ......................................................5
2.5V, 4.4A / 11W PKR 4919B SI ......................................................8
3.3V, 4.5A / 15W PKR 4110B SI ......................................................11
+3.3V, 1.5A / +5.0V, 1.4A / 12W PKR 4128B SI ......................................................14

EMC Specification ......................................................17
Operating Information ......................................................18
Thermal Consideration ......................................................19
Connections ......................................................20
Mechanical Information ......................................................21
Soldering Information ......................................................24
Delivery Information ......................................................26
Product Qualification Specification ......................................................27
### Ordering Information

<table>
<thead>
<tr>
<th>Product program</th>
<th>Output</th>
</tr>
</thead>
<tbody>
<tr>
<td>PKR 4918B SI</td>
<td>1.8 V, 5.0 A / 9 W</td>
</tr>
<tr>
<td>PKR 4919B SI</td>
<td>2.5 V, 4.4 A / 11 W</td>
</tr>
<tr>
<td>PKR 4110B SI</td>
<td>3.3 V, 4.5 A / 15 W</td>
</tr>
<tr>
<td>PKR 4218B SI</td>
<td>+3.3 V, 1.5 A / 5.0 V, 1.4 A / 12 W</td>
</tr>
</tbody>
</table>

See Contents for individual product ordering numbers.

<table>
<thead>
<tr>
<th>Option</th>
<th>Suffix</th>
<th>Ordering No.</th>
</tr>
</thead>
<tbody>
<tr>
<td>SMD, lead-free surface finish</td>
<td>S</td>
<td>PKR 4918B SI</td>
</tr>
<tr>
<td>Through hole pin</td>
<td>P</td>
<td>PKR 4918B PI</td>
</tr>
</tbody>
</table>

### General Information

#### Reliability

The Mean Time Between Failure (MTBF) is calculated at full output power and an operating ambient temperature (\(T_A\)) of +40°C, which is a typical condition in Information and Communication Technology (ICT) equipment. Different methods could be used to calculate the predicted MTBF and failure rate which may give different results. Flex currently uses one method, Telcordia SR332.

Predicted MTBF for the series is:

- 4.5 million hours according to Telcordia SR332, issue 1, Black box technique.

Telcordia SR332 is a commonly used standard method intended for reliability calculations in ICT equipment. The parts count procedure used in this method was originally modelled on the methods from MIL-HDBK-217F, Reliability Predictions of Electronic Equipment. It assumes that no reliability data is available on the actual units and devices for which the predictions are to be made, i.e. all predictions are based on generic reliability parameters.

#### Compatibility with RoHS requirements

The products are compatible with the relevant clauses and requirements of the RoHS directive 2011/65/EU and have a maximum concentration value of 0.1% by weight in homogeneous materials for lead, mercury, hexavalent chromium, PBB and PBDE and of 0.01% by weight in homogeneous materials for cadmium.

Exemptions in the RoHS directive utilized in Flex products are found in the Statement of Compliance document.

Flex fulfills and will continuously fulfill all its obligations under regulation (EC) No 1907/2006 concerning the registration, evaluation, authorization and restriction of chemicals (REACH) as they enter into force and is through product materials declarations preparing for the obligations to communicate information on substances in the products.

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Safety Specification

General information

Flex DC/DC converters and DC/DC regulators are designed in accordance with the safety standards IEC 60950-1, EN 60950-1 and UL 60950-1 Safety of Information Technology Equipment.

IEC/EN/UL 60950-1 contains requirements to prevent injury or damage due to the following hazards:

- Electrical shock
- Energy hazards
- Fire
- Mechanical and heat hazards
- Radiation hazards
- Chemical hazards

On-board DC/DC converters and DC/DC regulators are defined as component power supplies. As components they cannot fully comply with the provisions of any safety requirements without “conditions of acceptability”. Clearance between conductors and between conductive parts of the component power supply and conductors on the board in the final product must meet the applicable safety requirements. Certain conditions of acceptability apply for component power supplies with limited stand-off (see Mechanical Information and Safety Certificate for further information). It is the responsibility of the installer to ensure that the final product housing these components complies with the requirements of all applicable safety standards and regulations for the final product.

Component power supplies for general use should comply with the requirements in IEC/EN/UL 60950-1 Safety of Information Technology Equipment. Product related standards, e.g. IEEE 802.3af Power over Ethernet, and ETS-300132-2 Power interface at the input to telecom equipment, operated by direct current (dc) are based on IEC/EN/UL 60950-1 with regards to safety.

Flex DC/DC converters, Power interface modules and DC/DC regulators are UL 60950-1 recognized and certified in accordance with EN 60950-1. The flammability rating for all construction parts of the products meet requirements for V-0 class material according to IEC 60695-11-10, Fire hazard testing, test flames – 50 W horizontal and vertical flame test methods.

Isolated DC/DC converters & Power interface modules

The product may provide basic or functional insulation between input and output according to IEC/EN/UL 60950-1 (see Safety Certificate), different conditions shall be met if the output of a basic or a functional insulated product shall be considered as safety extra low voltage (SELV).

For basic insulated products (see Safety Certificate) the output is considered as safety extra low voltage (SELV) if one of the following conditions is met:

- The input source provides supplementary or double or reinforced insulation from the AC mains according to IEC/EN/UL 60950-1.
- The input source provides functional or basic insulation from the AC mains and the product’s output is reliably connected to protective earth according to IEC/EN/UL 60950-1.

For functional insulated products (see Safety Certificate) the output is considered as safety extra low voltage (SELV) if one of the following conditions is met:

- The input source provides double or reinforced insulation from the AC mains according to IEC/EN/UL 60950-1.
- The input source provides basic or supplementary insulation from the AC mains and the product’s output is reliably connected to protective earth according to IEC/EN/UL 60950-1.
- The input source is reliably connected to protective earth and provides basic or supplementary insulation according to IEC/EN/UL 60950-1 and the maximum input source voltage is 60 Vdc.

Galvanic isolation between input and output is verified in an electric strength test and the isolation voltage (Viso) meets the voltage strength requirement for basic insulation according to IEC/EN/UL 60950-1.

It is recommended to use a slow blow fuse at the input of each DC/DC converter. If an input filter is used in the circuit the fuse should be placed in front of the input filter. In the rare event of a component problem that imposes a short circuit on the input source, this fuse will provide the following functions:

- Isolate the fault from the input power source so as not to affect the operation of other parts of the system
- Protect the distribution wiring from excessive current and power loss thus preventing hazardous overheating
Absolute Maximum Ratings

<table>
<thead>
<tr>
<th>Characteristics</th>
<th>min</th>
<th>typ</th>
<th>max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>$T_{\text{ref}}$ Operating Temperature (see Thermal Consideration section)</td>
<td>-45</td>
<td></td>
<td>+110</td>
<td>°C</td>
</tr>
<tr>
<td>$T_{S}$ Storage temperature</td>
<td>-55</td>
<td></td>
<td>+125</td>
<td>°C</td>
</tr>
<tr>
<td>$V_i$ Input voltage</td>
<td>-0.5</td>
<td></td>
<td>+75</td>
<td>V</td>
</tr>
<tr>
<td>$V_{\text{iso}}$ Isolation voltage (input to output test voltage)</td>
<td>1500</td>
<td></td>
<td></td>
<td>Vdc</td>
</tr>
<tr>
<td>$V_{\text{tr}}$ Input voltage transient ($t_p 100$ ms)</td>
<td>100</td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>$V_{\text{RC}}$ Remote Control pin voltage (see Operating Information section)</td>
<td>Positive logic option</td>
<td>-5</td>
<td>16</td>
<td>V</td>
</tr>
<tr>
<td>$V_{\text{adj}}$ Adjust pin voltage (see Operating Information section)</td>
<td>-5</td>
<td></td>
<td>+40</td>
<td>V</td>
</tr>
</tbody>
</table>

Stress in excess of Absolute Maximum Ratings may cause permanent damage. Absolute Maximum Ratings, sometimes referred to as no destruction limits, are normally tested with one parameter at a time exceeding the limits of Output data or Electrical Characteristics. If exposed to stress above these limits, function and performance may degrade in an unspecified manner.

Fundamental Circuit Diagram

![Fundamental Circuit Diagram](image)
1.8V, 5A / 9W Electrical Specification

\( T_{\text{ref}} = -30 \text{ to } +95^\circ\text{C}, V_i = 36 \text{ to } 75 \text{ V}, \) unless otherwise specified under Conditions. Typical values given at: \( T_{\text{ref}} = +25^\circ\text{C}, V_i = 53 \text{ V}, \) max \( I_o, \) unless otherwise specified under Conditions.

<table>
<thead>
<tr>
<th>Characteristics</th>
<th>Conditions</th>
<th>min</th>
<th>typ</th>
<th>max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>( V_i ) Input voltage range</td>
<td></td>
<td>36</td>
<td>75</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>( V_{\text{off}} ) Turn-off input voltage Decreasing input voltage</td>
<td></td>
<td>30</td>
<td>33.5</td>
<td>35</td>
<td>V</td>
</tr>
<tr>
<td>( V_{\text{on}} ) Turn-on input voltage Increasing input voltage</td>
<td></td>
<td>32</td>
<td>34.5</td>
<td>36</td>
<td>V</td>
</tr>
<tr>
<td>( C_i ) Internal input capacitance</td>
<td></td>
<td>2 μF</td>
<td></td>
<td></td>
<td>μF</td>
</tr>
<tr>
<td>( P_o ) Output power</td>
<td>Output voltage initial setting</td>
<td>0</td>
<td>9</td>
<td></td>
<td>W</td>
</tr>
<tr>
<td>SVR Supply voltage rejection (ac)</td>
<td>( f = 100 \text{ Hz sinewave, } 1 \text{ Vp-p} )</td>
<td>65</td>
<td></td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>( η ) Efficiency</td>
<td></td>
<td>50 % of max ( I_o ) 82.0</td>
<td>max ( I_o ) 81.0</td>
<td>50 % of max ( I_o, V_i = 48 \text{ V} ) 83.0</td>
<td>max ( I_o, V_i = 48 \text{ V} ) 81.0</td>
</tr>
<tr>
<td>( P_d ) Power Dissipation</td>
<td>max ( I_o ) 2.2</td>
<td>2.9</td>
<td></td>
<td></td>
<td>W</td>
</tr>
<tr>
<td>( P_i ) Input idling power</td>
<td>( I_o = 0 \text{ A, } V_i = 53 \text{ V} )</td>
<td>470</td>
<td></td>
<td></td>
<td>mW</td>
</tr>
<tr>
<td>( P_{\text{standby}} ) Input standby power</td>
<td>( V_i = 53 \text{ V (turned off with RC)} )</td>
<td>43</td>
<td></td>
<td></td>
<td>mW</td>
</tr>
<tr>
<td>( f_s ) Switching frequency</td>
<td>0-100 % of max ( I_o ) 290</td>
<td>305</td>
<td>325</td>
<td></td>
<td>kHz</td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>Characteristic</th>
<th>Conditions</th>
<th>min</th>
<th>typ</th>
<th>max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>( V_{\text{Oi}} ) Output voltage initial setting and accuracy ( T_{\text{ref}} = +25^\circ\text{C}, V_i = 53 \text{ V}, ) max ( I_o )</td>
<td></td>
<td>1.77</td>
<td>1.8</td>
<td>1.84</td>
<td>V</td>
</tr>
<tr>
<td>Output adjust range</td>
<td></td>
<td>1.5</td>
<td>2.2</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Output voltage tolerance band</td>
<td>10-100 % of max ( I_o ) 1.71</td>
<td>1.89</td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Idling voltage ( I_o = 0 \text{ A} )</td>
<td></td>
<td>1.69</td>
<td>1.91</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Line regulation ( I_o ) max</td>
<td></td>
<td>15</td>
<td>60</td>
<td></td>
<td>mV</td>
</tr>
<tr>
<td>Load regulation ( V_i = 53 \text{ V, } 0-100 \text{ % of max } I_o )</td>
<td></td>
<td>20</td>
<td>100</td>
<td></td>
<td>mV</td>
</tr>
<tr>
<td>( V_v ) Load transient voltage deviation ( V_i = 53 \text{ V, Load step 25-75-25 } \text{ % of max } I_o, ) ( di/dt = 1 \text{ A}/\mu\text{s} )</td>
<td></td>
<td>±250</td>
<td></td>
<td></td>
<td>mV</td>
</tr>
<tr>
<td>( t_v ) Load transient recovery time ( \text{V} )</td>
<td></td>
<td>100</td>
<td></td>
<td></td>
<td>μs</td>
</tr>
<tr>
<td>( t_r ) Ramp-up time (from 10-90 % of ( V_o ))</td>
<td></td>
<td>1</td>
<td>1.8</td>
<td>3</td>
<td>ms</td>
</tr>
<tr>
<td>( t_s ) Start-up time (from ( V_i ) connection to 90 % of ( V_o ))</td>
<td></td>
<td>3</td>
<td>5</td>
<td>11</td>
<td>ms</td>
</tr>
<tr>
<td>( I_o ) Output current</td>
<td>0</td>
<td>5</td>
<td></td>
<td></td>
<td>A</td>
</tr>
<tr>
<td>( I_{\text{lim}} ) Current limit threshold ( V_o = 1.5 \text{ V, } T_{\text{ref}} &lt; \text{ max } T_{\text{ref}} )</td>
<td></td>
<td>5.2</td>
<td>6.1</td>
<td>6.4</td>
<td>A</td>
</tr>
<tr>
<td>( I_{\text{sc}} ) Short circuit current ( T_{\text{ref}} = 25^\circ\text{C}, ) See Operating Information section</td>
<td></td>
<td>6.2</td>
<td>7.0</td>
<td></td>
<td>A</td>
</tr>
<tr>
<td>( V_{\text{Oac}} ) Output ripple &amp; noise</td>
<td>See ripple &amp; noise section, max ( I_o, V_{\text{Oi}} )</td>
<td>10</td>
<td>30</td>
<td></td>
<td>mVp-p</td>
</tr>
</tbody>
</table>
1.8V, 5A / 9W Typical Characteristics

**Efficiency**

- Efficiency vs. load current and input voltage at $T_{\text{ref}} = +25^\circ$C

**Power Dissipation**

- Dissipated power vs. load current and input voltage at $T_{\text{ref}} = +25^\circ$C

**Output Current Derating**

- Available load current vs. ambient air temperature and airflow at $V_i = 53$ V. See Thermal Consideration section.

**Thermal Resistance**

- Thermal resistance vs. airspeed measured at the converter. Tested in wind tunnel with airflow and test conditions as per the Thermal Consideration section.

**Output Characteristics**

- Output voltage vs. load current at $T_{\text{ref}} = +25^\circ$C

**Current Limit Characteristics**

- Output voltage vs. load current at $I_0 > \text{max } I_0$, $T_{\text{ref}} = +25^\circ$C
1.8V, 5A / 9W Typical Characteristics

Start-up

Start-up enabled by connecting V\_i at:
\( T_{ref} = +25^\circ C, V_i = 53\ V,\ I_O = 5\ A \) resistive load.

Top trace: output voltage (0.5 V/div.).
Bottom trace: input voltage (20 V/div.).
Time scale: (2 ms/div.).

Shut-down

Shut-down enabled by disconnecting V\_i at:
\( T_{ref} = +25^\circ C, V_i = 53\ V,\ I_O = 5\ A \) resistive load.

Top trace: output voltage (1.0 V/div.).
Bottom trace: input voltage (50 V/div.).
Time scale: (1 ms/div.).

Output Ripple & Noise

Output voltage ripple at:
\( T_{ref} = +25^\circ C, V_i = 53\ V,\ I_O = 5\ A \) resistive load.
Trace: output voltage (20 mV/div.).
Time scale: (2 \( \mu \)s/div.).

Output Load Transient Response

Output voltage response to load current step-change (1.25-3.75-1.25 A) at:
\( T_{ref} = +25^\circ C, V_i = 53\ V.\)
Top trace: output voltage (200 mV/div.).
Bottom trace: load current (2 A/div.).
Time scale: (0.1 ms/div.).

Output Voltage Adjust (see operating information)

Passive adjust
The resistor value for an adjusted output voltage is calculated by using the following equations:

To adjust the output voltage upwards, a resistor is connected between pins 8 and 17. The output voltage increases when the resistance decreases. The resistance value is given by the equation:

\[ R_{ou} = 4.14 \times \left(1.28V_{oi} - V_{od}\right)/(V_{od} - V_{oi}) \text{ (kOhm)} \]

where \( V_{oi} \) is the desired output voltage and \( V_{oi} \) is the initial output voltage.

Active adjust
To adjust the output voltage downwards, a current source is connected to pin 18. The output voltage decreases when the connected current into pin 8 increases. The current value is given by the equation:

\[ I_{adj} = 943 \times \left(1 - (V_{oi}/V_{od})\right) \text{ (uA)} \]

where \( V_{oi} \) is the initial output voltage when pin 8 is disconnected, and \( V_{od} \) is the desired voltage.
## 2.5V, 4.4A / 11W Electrical Specification

\( T_{\text{ref}} = -30 \text{ to } +95^\circ C \), \( V_i = 36 \text{ to } 75 \text{ V} \), unless otherwise specified under Conditions.

Typical values given at: \( T_{\text{ref}} = +25^\circ C \), \( V_i = 53 \text{ V} \), max \( I_o \), unless otherwise specified under Conditions.

### Table: Electrical Characteristics

<table>
<thead>
<tr>
<th>Characteristics</th>
<th>Conditions</th>
<th>min</th>
<th>typ</th>
<th>max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>( V_i )</td>
<td>Input voltage range</td>
<td>36</td>
<td>75</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>( V_{\text{tref}} )</td>
<td>Turn-off input voltage</td>
<td>Decreasing input voltage</td>
<td>30</td>
<td>35</td>
<td>V</td>
</tr>
<tr>
<td>( V_{i\text{on}} )</td>
<td>Turn-on input voltage</td>
<td>Increasing input voltage</td>
<td>32</td>
<td>36</td>
<td>V</td>
</tr>
<tr>
<td>( C_i )</td>
<td>Internal input capacitance</td>
<td>2</td>
<td>2</td>
<td>μF</td>
<td></td>
</tr>
<tr>
<td>( P_o )</td>
<td>Output power</td>
<td>Output voltage initial setting</td>
<td>0</td>
<td>11</td>
<td>W</td>
</tr>
<tr>
<td>( SVR )</td>
<td>Supply voltage rejection (ac)</td>
<td>( f = 100 \text{ Hz} ) sinewave, 1 Vp-p</td>
<td>88</td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>( \eta )</td>
<td>Efficiency</td>
<td>50 % of max ( I_o )</td>
<td>84.0</td>
<td>84.0</td>
<td>%</td>
</tr>
<tr>
<td></td>
<td></td>
<td>max ( I_o )</td>
<td>84.0</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>50 % of max ( I_o ), ( V_i = 48 \text{ V} )</td>
<td>85.0</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>max ( I_o ), ( V_i = 48 \text{ V} )</td>
<td>84.0</td>
<td></td>
<td></td>
</tr>
<tr>
<td>( P_d )</td>
<td>Power Dissipation</td>
<td>max ( I_o )</td>
<td>2.1</td>
<td>2.7</td>
<td>W</td>
</tr>
<tr>
<td>( P_i )</td>
<td>Input idling power</td>
<td>( I_o = 0 \text{ A}, V_i = 53 \text{ V} )</td>
<td>610</td>
<td></td>
<td>mW</td>
</tr>
<tr>
<td>( P_{\text{nic}} )</td>
<td>Input standby power</td>
<td>( V_i = 53 \text{ V} ) (turned off with RC)</td>
<td>57</td>
<td></td>
<td>mW</td>
</tr>
<tr>
<td>( f_s )</td>
<td>Switching frequency</td>
<td>0-100 % of max ( I_o )</td>
<td>290</td>
<td>305</td>
<td>325</td>
</tr>
<tr>
<td>( V_{o\text{in}} )</td>
<td>Output voltage initial setting and accuracy</td>
<td>( T_{\text{ref}} = +25^\circ C ), ( V_i = 53 \text{ V} ), max ( I_o )</td>
<td>2.43</td>
<td>2.5</td>
<td>2.56</td>
</tr>
<tr>
<td>( V_o )</td>
<td>Output adjust range</td>
<td>2.2</td>
<td>2.8</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>( V_{o\text{b}} )</td>
<td>Output voltage tolerance band</td>
<td>10-100 % of max ( I_o )</td>
<td>2.38</td>
<td>2.58</td>
<td>V</td>
</tr>
<tr>
<td>( I_o )</td>
<td>Idling voltage</td>
<td>( I_o = 0 \text{ A} )</td>
<td>2.36</td>
<td>2.65</td>
<td>V</td>
</tr>
<tr>
<td>( \text{Line regulation} )</td>
<td>max ( I_o )</td>
<td>14</td>
<td>35</td>
<td>mV</td>
<td></td>
</tr>
<tr>
<td>( \text{Load regulation} )</td>
<td>( V_i = 53 \text{ V}, 0-100 % \text{ of max I}_{o} )</td>
<td>22</td>
<td>116</td>
<td>mV</td>
<td></td>
</tr>
<tr>
<td>( V_{o\text{load}} )</td>
<td>Load transient voltage deviation</td>
<td>( V_i = 53 \text{ V}, \text{Load step 25-75-25 % of max I}_{o}, \text{di/dt} = 1 \text{ A/μs} )</td>
<td>±220</td>
<td></td>
<td>mV</td>
</tr>
<tr>
<td>( t_{r} )</td>
<td>Load transient recovery time</td>
<td>( V_i = 53 \text{ V}, \text{Load step 25-75-25 % of max I}_{o} )</td>
<td>±220</td>
<td></td>
<td>mV</td>
</tr>
<tr>
<td>( t_{r} )</td>
<td>Ramp-up time (from ( 10-90 % \text{ of V}_{o} ))</td>
<td>10-100 % of max ( I_o )</td>
<td>70</td>
<td></td>
<td>μs</td>
</tr>
<tr>
<td>( t_{s} )</td>
<td>Start-up time (from ( V_i ) connection to 90 % of ( V_{o\text{in}} ))</td>
<td>10-100 % of max ( I_o )</td>
<td>2</td>
<td>5</td>
<td>18</td>
</tr>
<tr>
<td>( I_o )</td>
<td>Output current</td>
<td>0</td>
<td>4.4</td>
<td>A</td>
<td></td>
</tr>
<tr>
<td>( I_{\text{lim}} )</td>
<td>Current limit threshold</td>
<td>( V_o = 2.2 \text{ V}, T_{\text{ref}} &lt; \text{max } T_{\text{ref}} )</td>
<td>5.2</td>
<td>6.1</td>
<td>7</td>
</tr>
<tr>
<td>( I_{\text{sc}} )</td>
<td>Short circuit current</td>
<td>( T_{\text{ref}} = 25^\circ C ), See Operating Information section</td>
<td>6.5</td>
<td>7.5</td>
<td>A</td>
</tr>
<tr>
<td>( V_{\text{osc}} )</td>
<td>Output ripple &amp; noise</td>
<td>See ripple &amp; noise section, max ( I_o, V_{o\text{in}} )</td>
<td>8</td>
<td>20</td>
<td>mVp-p</td>
</tr>
</tbody>
</table>
2.5V, 4.4A / 11W Typical Characteristics

Efficiency

![Efficiency Graph]

Efficiency vs. load current and input voltage at $T_{\text{ref}} = +25^\circ C$

Power Dissipation

![Power Dissipation Graph]

Dissipated power vs. load current and input voltage at $T_{\text{ref}} = +25^\circ C$

Output Current Derating

![Output Current Derating Graph]

Available load current vs. ambient air temperature and airflow at $V_i = 53$ V. See Thermal Consideration section.

Thermal Resistance

![Thermal Resistance Graph]

Thermal resistance vs. airspeed measured at the converter. Tested in wind tunnel with airflow and test conditions as per the Thermal consideration section.

Output Characteristics

![Output Characteristics Graph]

Output voltage vs. load current at $T_{\text{ref}} = +25^\circ C$

Current Limit Characteristics

![Current Limit Characteristics Graph]

Output voltage vs. load current at $I_O > \text{max } I_O$, $T_{\text{ref}} = +25^\circ C$
2.5V, 4.4A / 11W Typical Characteristics

**Start-up**
- Start-up enabled by connecting $V_i$ at: $T_{ref} = +25°C$, $V_i = 53\,V$, $I_O = 4.4\,A$ resistive load.
- Top trace: output voltage (1.0 V/div.).
- Bottom trace: input voltage (20 V/div.).
- Time scale: (2 ms/div.).

**Shut-down**
- Shut-down enabled by disconnecting $V_i$ at: $T_{ref} = +25°C$, $V_i = 53\,V$, $I_O = 4.4\,A$ resistive load.
- Top trace: output voltage (1.0 V/div.).
- Bottom trace: input voltage (50 V/div.).
- Time scale: (1 ms/div.).

**Output Ripple & Noise**
- Output voltage ripple at: $T_{ref} = +25°C$, $V_i = 53\,V$, $I_O = 4.4\,A$ resistive load.
- Trace: output voltage (20 mV/div.).
- Time scale: (2 μs/div.).

**Output Load Transient Response**
- Output voltage response to load current step-change (1.1-1.3-1.1 A) at: $T_{ref} = +25°C$, $V_i = 53\,V$.
- Top trace: output voltage (200 mV/div.).
- Bottom trace: load current (2 A/div.).
- Time scale: (0.1 ms/div.).

### Output Voltage Adjust (see operating information)

**Passive adjust**
- The resistor value for an adjusted output voltage is calculated by using the following equations:

  $R_{ou} = 4.14 \times \frac{(1.28V_{oi} - V_{od})}{(V_{od} - V_{oi})}$ (kOhm); $V_{oi}$ is the initial output voltage and $V_{od}$ is the desired output voltage.

**Active adjust**
- To adjust the output voltage downwards, a current source is connected to pin 18. The output voltage decreases when the connected current into pin 8 increases. The current value is given by the equation:

  $I_{adj} = 943 \times (1-(V_{oi}/V_{od}))\,μA$; $V_{oi}$ is the initial output voltage when pin 8 is disconnected, $V_{od}$ is the desired voltage.
3.3V, 4.5A / 15W Electrical Specification

**Characteristics** | **Conditions** | **min** | **typ** | **max** | **Unit**  
---|---|---|---|---|---  
\( V_i \) | Input voltage range | 36 | 75 | | V  
\( V_{\text{IOff}} \) | Turn-off input voltage | Decreasing input voltage | 30 | 33.5 | 35 | V  
\( V_{\text{Ion}} \) | Turn-on input voltage | Increasing input voltage | 32 | 34.4 | 36 | V  
\( C_i \) | Internal input capacitance | | 2 | | µF  
\( P_o \) | Output power | Output voltage initial setting | 0 | 15 | | W  
SVR | Supply voltage rejection (ac) | \( f = 100 \text{ Hz sine wave}, 1 \text{ Vp-p} \) | 77 | | | dB  
\( \eta \) | Efficiency | 50 % of max \( I_o \) | 85.0 | | | %  
| | max \( I_o \) | 86.0 | | |  
| | 50 % of max \( I_o \), \( V_i = 48 \text{ V} \) | 85.0 | | |  
| | max \( I_o \), \( V_i = 48 \text{ V} \) | 86.0 | | |  
\( P_s \) | Power Dissipation | max \( I_o \) | 2.5 | 3.1 | | W  
\( P_i \) | Input idling power | \( I_o = 0 \text{ A}, V_i = 53 \text{ V} \) | 780 | | | mW  
\( P_{\text{SC}} \) | Input standby power | \( V_i = 53 \text{ V} \) (turned off with RC) | 41 | | | mW  
\( f_s \) | Switching frequency | | 290 | 305 | 325 | kHz  

**Output voltage initial setting and accuracy**  
\( V_o \) | | 3.23 | 3.30 | 3.36 | | V  

**Output adjust range**  
\( V_o \) | | 2.80 | 3.80 | | | V  

**Output voltage tolerance band**  
\( V_o \) | | 3.10 | 3.43 | | | V  

**Idling voltage**  
| \( I_o = 0 \text{ A} \) | 3.14 | 3.47 | | | V  

**Line regulation**  
| max \( I_o \) | | 30 | 50 | | mV  

**Load regulation**  
| \( V_i = 53 \text{ V}, 0-100 \text{ % of max} \( I_o \) | | 20 | 80 | | mV  

**Load transient voltage deviation**  
| \( V_i = 53 \text{ V}, \text{ Load step} 25-75-25 \text{ % of max} \( I_o \), \( \text{di/dt} = 1 \text{ A/μs} \) | | ±250 | | | mV  

**Load transient recovery time**  
| \( t_r \) | | 100 | | | μs  

**Ramp-up time**  
| (from 10-90 % of \( V_o) \) | 10-100 % of max \( I_o \) | 1 | 2 | 3 | | ms  

**Start-up time**  
| (from \( V_i \) connection to 90 % of \( V_o) \) | 2 | 6 | 9 | | ms  

**Output current**  
| \( I_o \) | | 0 | 4.5 | | | A  

**Current limit threshold**  
| \( V_o = 3.0 \text{ V}, T_{\text{ref}} < \text{max} T_{\text{ref}} \) | | 4.6 | 5.2 | 5.6 | | A  

**Short circuit current**  
| \( T_{\text{ref}} = 25 \text{°C}, \text{ See Operating Information section} \) | | 5.6 | 6.6 | | | A  

**Output ripple & noise**  
| \( V_{\text{Oac}} \) | See ripple & noise section, max \( I_o, V_o \) | 10 | 20 | | | mVp-p
### Efficiency

**Efficiency vs. load current and input voltage at $T_{ref} = +25^\circ C$**

- **Efficiency** values are shown for different input voltages (36 V, 48 V, 53 V, 75 V).

### Power Dissipation

**Dissipated power vs. load current and input voltage at $T_{ref} = +25^\circ C$**

- **Power Dissipation** graph showing power dissipation for different load currents and input voltages.

### Output Current Derating

**Available load current vs. ambient air temperature and airflow at $V_i = 53$ V**

- **Current** derating graph showing current limits under various airflow conditions.

### Thermal Resistance

**Thermal resistance vs. airspeed measured at the converter.**

- **Thermal Consideration** section details test conditions.

### Output Characteristics

**Output voltage vs. load current at $T_{ref} = +25^\circ C$**

- **Output voltage** graph demonstrating output voltage changes.

### Current Limit Characteristics

**Output voltage vs. load current at $I_O > max I_O$, $T_{ref} = +25^\circ C$**

- **Current Limit** characteristics represented graphically.
3.3V, 4.5A / 15W Typical Characteristics

Start-up

Start-up enabled by connecting VI at:

\[ T_{ref} = +25^\circ C, V_I = 53 \text{ V, } I_O = 4.5 \text{ A resistive load.} \]

Top trace: output voltage (1.0 V/div.),
Bottom trace: input voltage (50 V/div.),
Time scale: (5 ms/div.).

Output Ripple & Noise

Output voltage ripple at:

\[ T_{ref} = +25^\circ C, V_I = 53 \text{ V, } I_O = 4.5 \text{ A resistive load.} \]

Trace: output voltage (20 mV/div.),
Time scale: (2 \mu s/div.).

Shut-down

Shut-down enabled by disconnecting VI at:

\[ T_{ref} = +25^\circ C, V_I = 53 \text{ V, } I_O = 4.5 \text{ A resistive load.} \]

Top trace: output voltage (1.0 V/div.),
Bottom trace: input voltage (20 V/div.),
Time scale: (200 ms/div.).

Output Load Transient Response

Output voltage response to load current step-change (1.12-3.38-1.12 A) at:

\[ T_{ref} = +25^\circ C, V_I = 53 \text{ V.} \]

Top trace: output voltage (200 mV/div.),
Bottom trace: load current (2 A/div.),
Time scale: (0.1 ms/div.).

Output Voltage Adjust (see operating information)

Passive adjust
The resistor value for an adjusted output voltage is calculated by using the following equations:

To adjust the output voltage upwards, a resistor is connected between pins 8 and 17. The output voltage increases when the resistance decreases. The resistance value is given by the equation:

\[ R_{ou} = 4.14 \times (1.28V_i - V_o)/(V_o - V_i) \text{ (kOhm);} \]

\[ V_o \text{ is the desired output voltage and } V_i \text{ is the initial output voltage.} \]

Active adjust
To adjust the output voltage downwards, a current source is connected to pin 18. The output voltage decreases when the connected current into pin 8 increases. The current value is given by the equation:

\[ I_{adj} = 943 \times (1 - (V_{od}/V_{oi})) \text{ [mA]; } V_i \text{ is the initial output voltage when pin 8 is disconnected, } V_{od} \text{ is the desired voltage.} \]
+3.3V, 1.5A / +5V, 1.4A / 12W Dual, Electrical Specification

$T_{ref} = -30$ to $+95^\circ$C, $V_i = 36$ to 75 V, unless otherwise specified under Conditions.

Typical values given at: $T_{ref} = +25^\circ$C, $V_i = 53$ V, max $I_O$ unless otherwise specified under Conditions.

### Characteristics

<table>
<thead>
<tr>
<th>Characteristics</th>
<th>Conditions</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>$V_i$ Input voltage range</td>
<td>36</td>
<td>75</td>
</tr>
<tr>
<td>$V_{off}$ Turn-off input voltage</td>
<td>Decreasing input voltage</td>
<td>V</td>
</tr>
<tr>
<td>$V_{on}$ Turn-on input voltage</td>
<td>Increasing input voltage</td>
<td>V</td>
</tr>
<tr>
<td>$C_i$ Internal input capacitance</td>
<td>2</td>
<td>μF</td>
</tr>
<tr>
<td>$P_o$ Output power</td>
<td>Output voltage initial setting</td>
<td>W</td>
</tr>
<tr>
<td>$SVR$ Supply voltage rejection (ac)</td>
<td>$f = 100$ Hz sinewave, 1 Vp-p</td>
<td>dB</td>
</tr>
<tr>
<td>$\eta$ Efficiency at 50 % of max power</td>
<td>$I_{o1} = 0.75$ A, $I_{o2} = 1.4$ A</td>
<td>%</td>
</tr>
<tr>
<td>$\eta$ Efficiency at max power</td>
<td>$I_{o1} = 1.5$ A, $I_{o2} = 1.4$ A</td>
<td>%</td>
</tr>
<tr>
<td>$P_d$ Power Dissipation at max power</td>
<td>$I_{o1} = 1.5$ A, $I_{o2} = 1.4$ A</td>
<td>W</td>
</tr>
<tr>
<td>$P_{id}$ Input idling power</td>
<td>$I_o = 0$ A, $V_i = 53$ V</td>
<td>mW</td>
</tr>
<tr>
<td>$P_{RC}$ Input standby power</td>
<td>$V_i = 53$ V (turned off with RC)</td>
<td>mW</td>
</tr>
<tr>
<td>$f_s$ Switching frequency</td>
<td>$I_{o1} = 0.75$ A, $I_{o2} = 1.4$ A</td>
<td>kHz</td>
</tr>
</tbody>
</table>

### Output 1

<table>
<thead>
<tr>
<th>Characteristics</th>
<th>Conditions</th>
<th>min</th>
<th>typ</th>
<th>max</th>
</tr>
</thead>
<tbody>
<tr>
<td>$V_o$ Output voltage initial setting and accuracy</td>
<td>$T_{ref} = +25^\circ$C, $V_i = 53$ V, $I_{o1} = 1.5$ A, $I_{o2} = 1.4$ A</td>
<td>3.23</td>
<td>3.30</td>
<td>3.36</td>
</tr>
<tr>
<td>$V_o$ Output adjust range</td>
<td>$10 -100%$ of max $I_O$</td>
<td>3.06</td>
<td>3.47</td>
<td>4.63</td>
</tr>
<tr>
<td>$V_o$ Output voltage tolerance band</td>
<td>$10-100 %$ of max $I_O$</td>
<td>3.18</td>
<td>3.39</td>
<td>4.83</td>
</tr>
<tr>
<td>$V_o$ Idling voltage</td>
<td>$I_o = 0$ A</td>
<td>3.25</td>
<td>3.31</td>
<td>4.82</td>
</tr>
<tr>
<td>$V_o$ Load regulation output 1</td>
<td>$V_i = 53$ V, $I_{o1} = 10-100 %$ of max, $I_{o2} = 1.4$ A</td>
<td>69</td>
<td>96</td>
<td></td>
</tr>
<tr>
<td>$V_o$ Load regulation output 2</td>
<td>$V_i = 53$ V, $I_{o1} = 1.5$ A, $I_{o2} = 10-100 %$ of max</td>
<td>25</td>
<td>57</td>
<td></td>
</tr>
</tbody>
</table>

### Output 2

<table>
<thead>
<tr>
<th>Characteristics</th>
<th>Conditions</th>
<th>min</th>
<th>typ</th>
<th>max</th>
</tr>
</thead>
<tbody>
<tr>
<td>$V_o$ Load transient voltage deviation</td>
<td>$V_i = 53$ V, Load step $I_{o1}$ 25-75-25 % of max, $I_{o2} = 1.4$ A, $di/dt = 1$ A/μs</td>
<td>±130</td>
<td>±245</td>
<td></td>
</tr>
<tr>
<td>$t_o$ Load transient recovery time</td>
<td>80</td>
<td>100</td>
<td>μs</td>
<td></td>
</tr>
<tr>
<td>$t_o$ Ramp-up time (from 10-90 % of $V_{o1}$)</td>
<td>0.1</td>
<td>2.4</td>
<td>5.8</td>
<td>ms</td>
</tr>
<tr>
<td>$t_o$ Start-up time (from $V_i$ connection to 90 % of $V_{o1}$)</td>
<td>0.1</td>
<td>5.4</td>
<td>11.3</td>
<td>ms</td>
</tr>
<tr>
<td>$I_o$ Output current</td>
<td>0</td>
<td>1.5</td>
<td>A</td>
<td></td>
</tr>
<tr>
<td>$I_{lim}$ Current limit threshold</td>
<td>$V_{o1} = 2.5$ V, $V_{o2} = 4.0$ V, $T_{ref} &lt; max T_{ref}$</td>
<td>2.6</td>
<td>3.2</td>
<td>3.6</td>
</tr>
<tr>
<td>$I_{sc}$ Short circuit current</td>
<td>$T_{ref} = 25^\circ$C, See Operating Information section</td>
<td>5.2</td>
<td>5.4</td>
<td>3.3</td>
</tr>
<tr>
<td>$V_{dec}$ Output ripple &amp; noise</td>
<td>See ripple &amp; noise section, max $I_{o1}$, $V_o$</td>
<td>10</td>
<td>20</td>
<td>18</td>
</tr>
</tbody>
</table>

© Flex
PKR 4000B series Direct Converters
Input 36-75 V, Output up to 5 A / 15 W

+3.3V, 1.5A / +5V, 1.4A / 12W Dual, Typical
Characteristics

**Efficiency**

Efficiency vs. load current and input voltage at $T_{ref} = +25^\circ$C

**Power Dissipation**

Dissipated power vs. load current and input voltage at $T_{ref} = +25^\circ$C

**Output Power Derating**

Available load current vs. ambient air temperature and airflow at $V_I = 53$ V. See Thermal Consideration section.

**Thermal Resistance**

Thermal resistance vs. airspeed measured at the converter. Tested in wind tunnel with airflow and test conditions as per the Thermal Consideration section.

**Output 1 Characteristics**

Output 1 Cross Regulation

Operation area for ± 4% tolerance at $TP1 = +25^\circ$C

**Output 2 Cross Regulation**

Output 2 Characteristics

Operation area for ± 4% tolerance at $TP1 = +25^\circ$C
PKR 4000B series Direct Converters
Input 36-75 V, Output up to 5 A / 15 W

+3.3V, 1.5A / +5V, 1.4A / 12W Dual, Typical
Characteristics

Start-up

![Start-up Graph]

Shut-down

![Shut-down Graph]

Output Ripple & Noise

![Output Ripple & Noise Graph]

Output Load Transient Response

![Output Load Transient Response Graph]

Output Voltage Adjust (see operating information)

**Passive adjust**
The resistor value for an adjusted output voltage is calculated by using the following equations:

To adjust the output voltage upwards, a resistor is connected between pins 8 and 17. The output voltage increases when the resistance decreases. The resistance value is given by the equation:

$$R_{ou} = \frac{4.14 \times (1.28V_i - V_o)\text{/(}V_0 - V_i)}{(V_0 - V_i)\text{/(kOhm)}}; \quad V_o \text{ is the desired output voltage and } V_i \text{ is the initial output voltage.}$$

**Active adjust**
To adjust the output voltage downwards, a current source is connected to pin 18. The output voltage decreases when the connected current into pin 8 increases. The current value is given by the equation:

$$I_{adj} = 943 \times (1 - \frac{V_o}{V_i})\text{[uA]}; \quad V_i \text{ is the initial output voltage when pin 8 is disconnected, } V_o \text{ is the desired voltage.}$$
EMC Specification

Conducted EMI measured according to EN55022, CISPR 22 and FCC part 15J (see test set-up). See Design Note 009 for further information. The fundamental switching frequency is 305 kHz for PKR 4110B SI @ $V_I = 53$ V, max $I_O$.

**Conducted EMI Input terminal value (typ)**

![EMI without filter](image)

**External filter (class B)**

Required external input filter in order to meet class B in EN 55022, CISPR 22 and FCC part 15J.

Filter components:
- $C_1 = 1\mu F$ 100V
- $C_2 = 10\mu F$ 100V
- $C_3, C_4 = 2.2nF$
- $1500Vdc$
- $L_1 = $Pulse PO354 1.17mH

![EMI with filter](image)

**Test set-up**

**Layout recommendation**

The radiated EMI performance of the DC/DC converter will depend on the PCB layout and ground layer design. It is also important to consider the stand-off of the DC/DC converter.

A ground layer will increase the stray capacitance in the PCB and improve the high frequency EMC performance.

**Output ripple and noise**

Output ripple and noise measured according to figure below.

![Output ripple and noise test setup](image)
Operating information

Input Voltage
The input voltage range 36...75Vdc meets the requirements of the European Telecom Standard ETS 300 132-2 for normal input voltage range in –48 and –60 Vdc systems, -40.5...-57.0 V and –50.0...-72 V respectively. At input voltages exceeding 75 V, the power loss will be higher than at normal input voltage and T_{ref} must be limited to absolute max +95°C. The absolute maximum continuous input voltage is 75 Vdc.

Turn-off Input Voltage
The converters monitor the input voltage and will turn on and turn off at predetermined levels. The minimum hysteresis between turn on and turn off input voltage is 1V.

Remote Control (RC)
The products are fitted with a remote control function referenced to the primary negative input connection (- In), and have positive logic. The RC function allows the converter to be turned on/off by an external device like a semiconductor or mechanical switch.

The maximum required sink current is 1 mA. When the RC pin is left open, the voltage generated on the RC pin is <16 V. To ensure that the converter stays off the voltage must be below 1.0 V.

Input and Output Impedance
The impedance of both the input source and the load will interact with the impedance of the DC/DC converter. It is important that the input source has low characteristic impedance. The converters are designed for stable operation without external capacitors connected to the input or output. The performance in some applications can be enhanced by addition of external capacitance as described under External Decoupling Capacitors. If the input voltage source contains significant inductance, the addition of a 10 µF capacitor across the input of the converter will ensure stable operation. The capacitor is not required when powering the DC/DC converter from an input source with an inductance below 10 µH.

External Decoupling Capacitors
When powering loads with significant dynamic current requirements, the voltage regulation at the point of load can be improved by addition of decoupling capacitors at the load. The most effective technique is to locate low ESR ceramic and electrolytic capacitors as close to the load as possible by using several parallel capacitors to lower the effective ESR. The ceramic capacitors will handle high-frequency dynamic load changes while the electrolytic capacitors are used to handle low frequency dynamic load changes. Ceramic capacitors will also reduce any high frequency noise at the load.

It is equally important to use low resistance and low inductance PCB layouts and cabling.

External decoupling capacitors will become part of the control loop of the DC/DC converter and may affect the stability margins. As a “rule of thumb”, 100 µF/A of output current can be added without any additional analysis. The recommended absolute maximum value of output capacitance is 10 000 µF. For further information please contact your local Flex Power Modules representative.

Output Voltage Adjust (V_{adj})
All converters have an Output Voltage Adjust pin (V_{adj}). This pin can be used to adjust the output voltage above or below Output voltage initial setting. At increased output voltages the maximum power rating of the converter remains the same, and the max output current must be decreased correspondingly.

The output voltage can be increased or decreased by means of external resistors or other external circuitry. If other circuitry is used, the slew rate has to be limited to maximum 5V/ms. To increase the voltage the resistor should be connected between the V_{adj} pin and -IN. To decrease the output voltage, a current source is connected into V_{adj} pin. The resistor and current source value of the Output voltage adjust function is according to information given under the Output section for the respective product.
Parallel Operation

It is not recommended to parallel the converters without using external current sharing circuits.

Over Temperature Protection (OTP)

The PKR 4000B Series DC/DC converters include an internal over temperature shutdown circuit. When the temperature exceeds 130°C - 150°C on the control circuit the converter will shut down. The DC/DC converter will make continuous attempts to start up (non-latching mode) and resume normal operation automatically when the temperature has dropped >15°C below the temperature threshold.

Over Current Protection (OCP)

The converters include current limiting circuitry for protection at continuous overload. The output voltage will decrease towards zero for output currents in excess of max output current (max I_O). The converter will resume normal operation after removal of the overload. The load distribution should be designed for the maximum output short circuit current specified.

General

The converters are designed to operate in different thermal environments and sufficient cooling must be provided to ensure reliable operation. Cooling is achieved mainly by conduction, from the pins to the PCB board, and convection, which is dependant on the airflow across the converter. Increased airflow enhances the cooling of the converter.

The Output Current Derating graph found in the Output section for each model provides the available output current vs. ambient air temperature and air velocity at V_in = 53 V.

The converter is tested on a 254 x 254 mm, 35 µm (1 oz), 8-layer test board mounted vertically in a wind tunnel with a cross-section of 305 x 305 mm.

Proper cooling of the converter can be verified by measuring the temperature at position P1. The temperature at these positions should not exceed the max values provided in the table below.

Note that the max value is the absolute maximum rating (non destruction) and that the electrical Output data is guaranteed up to T_ref +95°C.

See Design Note 019 for further information.

<table>
<thead>
<tr>
<th>Position</th>
<th>Device</th>
<th>Designation</th>
<th>max value</th>
</tr>
</thead>
<tbody>
<tr>
<td>P_1</td>
<td>Transformer</td>
<td>T_ref</td>
<td>110°C</td>
</tr>
<tr>
<td>P_2</td>
<td>Mosfet</td>
<td></td>
<td></td>
</tr>
<tr>
<td>P_3</td>
<td>PCB</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Thermal Consideration
**Thermal Consideration continued**

**Definition of reference temperature (T_{ref})**

The reference temperature is used to monitor the temperature limits of the product. Temperatures above maximum T_{ref} are not allowed and may cause degradation or permanent damage to the product. T_{ref} is also used to define the temperature range for normal operating conditions. T_{ref} is defined by the design and used to guarantee safety margins, proper operation and high reliability of the module.

**Ambient Temperature Calculation**

By using the thermal resistance the maximum allowed ambient temperature can be calculated.

1. The power loss is calculated by using the formula \((1/\eta - 1) \times \text{output power} = \text{power losses (Pd)}\).
   \[ \eta = \text{efficiency of converter. E.g 86% = 0.86} \]
   \[ \text{1. } (1/0.86 - 1) \times 14.85 \text{ W} = 2.42 \text{ W} \]
2. Find the thermal resistance (Rth) in the Thermal Resistance graph found in the Output section for each model. Calculate the temperature increase (\(\Delta T\)).
   \[ \Delta T = Rth \times Pd \]
3. Max allowed ambient temperature is:
   \[ \text{Max } T_{ref} - \Delta T \]

E.g PKR 4110B SI at 1m/s:

1. \((1/0.86 - 1) \times 14.85 \text{ W} = 2.42 \text{ W} \]
2. \(2.42 \text{ W} \times 10{\degree}\text{C/W} = 24.2{\degree}\text{C} \]
3. \(110 \text{ }{\degree}\text{C} - 24.2{\degree}\text{C} = \text{max ambient temperature is 85.8{\degree}\text{C}} \]

The actual temperature will be dependent on several factors such as the PCB size, number of layers and direction of airflow.

**Connections**

<table>
<thead>
<tr>
<th>Pin</th>
<th>Designation</th>
<th>Function</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>Out 1</td>
<td>Output 1</td>
</tr>
<tr>
<td>2</td>
<td>Rtn</td>
<td>Output return</td>
</tr>
<tr>
<td>3</td>
<td>Out 1/ Out 2*</td>
<td>Out 1/ Out 2*</td>
</tr>
<tr>
<td>4</td>
<td>NC</td>
<td>Not connected</td>
</tr>
<tr>
<td>5</td>
<td>NC</td>
<td>Not connected</td>
</tr>
<tr>
<td>6</td>
<td>NC</td>
<td>Not connected</td>
</tr>
<tr>
<td>7</td>
<td>NC</td>
<td>Not connected</td>
</tr>
<tr>
<td>8</td>
<td>Vadj</td>
<td>Output voltage adjust</td>
</tr>
<tr>
<td>9</td>
<td>NC**</td>
<td>Not connected**</td>
</tr>
<tr>
<td>10</td>
<td>NC</td>
<td>Not connected</td>
</tr>
<tr>
<td>11</td>
<td>RC</td>
<td>Remote control. Used to turn-on/off output</td>
</tr>
<tr>
<td>12</td>
<td>NC</td>
<td>Not connected</td>
</tr>
<tr>
<td>13</td>
<td>NC</td>
<td>Not connected</td>
</tr>
<tr>
<td>14</td>
<td>NC</td>
<td>Not connected</td>
</tr>
<tr>
<td>15</td>
<td>NC</td>
<td>Not connected</td>
</tr>
<tr>
<td>16</td>
<td>NC</td>
<td>Not connected</td>
</tr>
<tr>
<td>17</td>
<td>- In</td>
<td>Negative input</td>
</tr>
<tr>
<td>18</td>
<td>+ In</td>
<td>Positive input</td>
</tr>
</tbody>
</table>

* Only for duals

** For the corresponding discontinued PKF 4000B series pin 8 and 9 had to be connected, this is not needed on the PKR 4000B series.
PKR 4000B series Direct Converters
Input 36-75 V, Output up to 5 A / 15 W

Mechanical Information – Surface Mount Version

NOTES

1. The solder bumps are designed to allow capacitance compensation by melting of the solder bumps between the product and the application board. The capacitance corresponds to the requirements for BGA (ball grid array) balls. (Jedec Publication 95, Design Guide 4.14 revision 6, September 2005)

2. Max product height is measured from bottom side of the product PCB but excluding the solder bump (reduced to solder joint thickness after assembly).

3. Absolute keep out area = 48.8 x 29.1 based on mechanical outline and assembly tolerances. The recommended keep out area is +3 mm on each long side to facilitate repair (removal and re-mounting) with a hot air nozzle.

4. Pickup surface on marking label is 10.5 x 11.00 (0.413 x 0.433). Pickup location varies between product variants.

Weight: 9.12 g
All dimensions in mm (inch)
Tolerances unless specified
± xx mm ±0.01 [0.03], ± xxx mm ±0.13 [0.005]
Not applied on footprint or typical values
PKR 4000B series Direct Converters
Input 36-75 V, Output up to 5 A / 15 W

Assembly Information – Surface Mount Version

The recommended footprint (see previous page) is optimised for the solder bump design. However, the standard PKF footprint will also accommodate this solder bump design. The only difference is the solder pad width (2.8 versus 2.3 mm) and the c-c distance between the two rows of solder lands (26.8 versus 26.6 mm).

The absolute and recommended keep out areas are not affected by the differences in application board footprint.

Weight: 9.12 g
All dimensions in mm [inch]
Tolerances unless specified
xx mm ±0.26 [0.01], xxx mm ±0.13 [0.005]
(not applied on footprint or typical values)
PKR 4000B series Direct Converters
Input 36-75 V, Output up to 5 A / 15 W

Mechanical Information – Hole Mount Version

Through hole mount product height
0.50
Max
0.335

Component outline

Lead length
3.2
(0.126)

0.65
(0.026) (8x)

0.35
(0.014) (3x)

5.00
(0.197)

Stand-off
130
(0.05)

Pin Specification
Material: CuSn6 (C9191)
Plating: 3 to 5 Mm matte Sn over minimum 1.5 Mm Ni

Mounting option
Suffix Description
P Plated through hole mounted

Recommended Footprint (top view, application board)

Recommended keep out area for user components

Weight: typical 11 g
All dimensions in mm [inch]
Tolerances unless specified
xx mm ±0.26 [0.01], xxx mm ±0.10 [0.004]
(not applied on footprint or typical values)
Soldering Information - Surface Mounting
The surface mount version of the product is intended for convection reflow or vapor phase reflow in SnPb or Pb-free reflow processes.

Mounting Options
The surface mount version is available in two options, SnPb based or SnAgCu based (Pb-free) solder bumps.

The SnPb solder bumps are intended for SnPb solder paste on the host board and to be reflowed in SnPb reflow process temperatures, typically +210 to +220°C.

The Pb-free solder bumps are intended for Pb-free solder paste on the host board and to be reflowed in Pb-free reflow process temperatures, typically +235 to +250°C.

Note that recommendations for minimum and maximum pin temperature – and maximum peak product temperature – are different depending on mounting option, reflow process type and if the dry packing of the products has been kept intact.

General Reflow Profile Recommendations
The reflow profile should be optimised to avoid excessive heating of the product. It is recommended to have a sufficiently extended preheat time to ensure an even temperature across the host PCB and to minimize the time in reflow.

A no-clean flux is recommended to avoid entrapment of cleaning fluids in cavities inside the product or between the product and the host board, since cleaning residues may affect long time reliability and isolation voltage.

Mixed Solder Process Recommendations
When using products with Pb-free solder bumps and thereby mixing Pb-free solder with SnPb paste on the host board and reflowing at SnPb process temperatures (backwards compatibility), special recommendations apply.

An extended preheat time between +170°C and +180°C for 60 to 90s and a pin reflow temperature (Tpin) between +220°C and +225°C for 30 to 60 s is recommended.

The extended preheat and soak at reflow temperature will minimize temperature gradients and maximize the wetting and solder mixing in the final solder joints. The use of nitrogen reflow atmosphere will further improve the solder joint quality.

Dry Pack Information
Products intended for Pb-free reflow processes are delivered in standard moisture barrier bags according to IPC/JEDEC standard J-STD-033 (Handling, packing, shipping and use of moisture/reflow sensitivity surface mount devices). The SnPb option of this product is also delivered in dry packing.

Using products in high temperature Pb-free soldering processes requires dry pack storage and handling. In case the products have been stored in an uncontrolled environment and no longer can be considered dry, the modules must be baked according to J-STD-033.

Thermocoupler Attachment
Top of PCB near pin 9 or pin 10 for measurement of maximum product temperature, TPRODUCT
Pin 5 of pin 14 for measurement of minimum pin (solder joint) temperature, Tpin
PKR 4000B series Direct Converters
Input 36-75 V, Output up to 5 A / 15 W

Pin Temperature Recommendations
Pin number 5 and 14 are chosen as reference locations for the minimum pin (solder joint) temperature recommendations since these will likely be the coolest solder joints during reflow.

SnPb Solder Processes
Minimum pin temperature: for SnPb solder processes, a pin temperature ($T_{\text{Pin}}$) in excess of the solder melting temperature, ($T_L$, $+183°C$ for Sn63Pb37) for more than 30 seconds, and a peak temperature of $+210°C$ is recommended to ensure a reliable solder joint.

A maximum pin temperature of $+225°C$ should be sufficient for most applications but depending on type of solder paste and flux system used on the host board, up to a recommended maximum temperature of $+245°C$ could be used, provided that the products are kept in a controlled environment (dry pack handling and storage) prior to assembly.

Pb-free Solder Processes
For Pb-free solder processes, a pin temperature ($T_{\text{Pin}}$) in excess of the solder melting temperature ($T_L$, $+217$ to $+221°C$ for SnAgCu solder alloys) for more than 30 seconds, and a peak temperature of $+235°C$ on all solder joints is recommended to ensure a reliable solder joint.

Surface Mount Assembly and Repair
The solder bumps of the product require particular care during assembly since the solder bumps are hidden between the host board and the product’s PCB. Special procedures are required for successful rework of these products.

Maximum Product Temperature Requirements
Top of the product PCB near pin 9 or 10 are chosen as reference locations for the maximum (peak) allowed product temperature ($T_{\text{PRODUCT}}$), since these will likely be the warmest parts of the product during the reflow process.

SnPb Solder Processes
For conventional SnPb solder processes, the product is qualified for MSL 1 according to IPC/JEDEC standard J-STD-020C (no dry pack handling or controlled environment required)

During reflow, $T_{\text{PRODUCT}}$ must not exceed $+225°C$ at any time.

If the products are handled as MSL 3 products, they can withstand up to $+260°C$ as in Pb-free solder processes.

Pb-free Solder Processes
For Pb-free solder processes, the product is qualified for MSL 3 according to IPC/JEDEC standard J-STD-020C.

During reflow, $T_{\text{PRODUCT}}$ must not exceed $+260°C$ at any time.

Repair
For a successful repair (removal and replacement) of a solder bump product, a dedicated rework system should be used. The rework system should preferably utilize a bottom side heater and a dedicated hot air nozzle to heat the solder bumps to reflow temperature.

Assembly
Automatic pick and place equipment should be used to mount the product on the host board. The use of a vision system, utilizing the fiducials on the bottom side of the product, will ensure adequate accuracy. Manual mounting of solder bump products is not recommended.

Note that the actual position of the pick up surface may vary between variants within the product program and is not necessarily in the center of the product outline.

If necessary, it is recommended to fine tune the solder print aperture size to optimize the amount of deposited solder with consideration to screen thickness and solder print capability.

Soldering Information – Hole Mounting
The hole mount version of the product is intended for manual or wave soldering in plated through holes on the host board. When wave soldering is used, the temperature on the pins is specified to maximum $+270°C$ for maximum 10 seconds. A maximum preheat rate of $4°C/s$ and a preheat temperature of max of $+150°C$ is suggested.

When soldering by hand, care should be taken to avoid direct contact between the hot soldering iron tip and the pins for more than a few seconds in order to prevent overheating.

A no-clean flux is recommended to avoid entrapment of cleaning fluids in cavities inside the product or between the product and the host board. The cleaning residues may affect long time reliability and isolation voltage.
Delivery Package Information
The surface mount version of the product is delivered in antistatic injection molded trays (Jedec design guide 4.10D standard) or in antistatic carrier tape (EIA 481 standard).

The hole mount version is delivered in antistatic tubes.

**Carrier Tape Specifications**

<table>
<thead>
<tr>
<th>Material</th>
<th>Polystyrene (PS), antistatic</th>
</tr>
</thead>
<tbody>
<tr>
<td>Surface resistivity</td>
<td>&lt; 10 Ohm/square</td>
</tr>
<tr>
<td>Bakability</td>
<td>The tape is not bakable</td>
</tr>
<tr>
<td>Tape width</td>
<td>72 mm [2.835 inch]</td>
</tr>
<tr>
<td>Pocket pitch</td>
<td>36 mm [1.417 inch]</td>
</tr>
<tr>
<td>Pocket depth</td>
<td>9.2 mm [0.362 inch]</td>
</tr>
<tr>
<td>Reel diameter</td>
<td>330 mm [13 inch]</td>
</tr>
<tr>
<td>Reel capacity</td>
<td>150 products / reel</td>
</tr>
<tr>
<td>Reel weight</td>
<td>Approximately 2.5 kg / full reel</td>
</tr>
</tbody>
</table>

**Tray Specifications**

<table>
<thead>
<tr>
<th>Material</th>
<th>PPE, antistatic</th>
</tr>
</thead>
<tbody>
<tr>
<td>Surface resistance</td>
<td>&lt; 10 Ohm/square</td>
</tr>
<tr>
<td>Bakability</td>
<td>The trays can be baked at maximum 125 °C for maximum 48 hours</td>
</tr>
<tr>
<td>Tray capacity</td>
<td>15 products / tray</td>
</tr>
<tr>
<td>Box capacity</td>
<td>150 products (10 full trays / box)</td>
</tr>
<tr>
<td>Tray weight</td>
<td>140 g empty, 320 g full tray maximum</td>
</tr>
</tbody>
</table>

**JEDEC standard tray**

Note: all tray dimensions refer to pocket center. Exact position of pickup point depends on the position of the pickup surface (top of main transformer) of the individual product variant.
## Product Qualification Specification

<table>
<thead>
<tr>
<th>Characteristics</th>
<th></th>
<th></th>
<th></th>
</tr>
</thead>
<tbody>
<tr>
<td>External visual inspection</td>
<td>IPC-A-610</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Operational life test</td>
<td>MIL-STD-202G method 108A With power cycling</td>
<td>Load</td>
<td>According to Absolute maximum ratings Maximum output power 500 h</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Duration</td>
<td></td>
</tr>
<tr>
<td>Vibration, broad band random</td>
<td>IEC 60068-2-64 Fh</td>
<td>Frequency</td>
<td>10 to 500 Hz 0.5 g²/Hz 10 min in each 3 perpendicular directions</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Acceleration spectral density</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>Duration and directions</td>
<td></td>
</tr>
<tr>
<td>Vibration, sinusoidal</td>
<td>IEC 68-2-64 Fc</td>
<td>Frequency</td>
<td>10 to 500 Hz</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Amplitude</td>
<td>0.75 mm</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Acceleration</td>
<td>10 g</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Sweep rate</td>
<td>1 octave/min</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Duration</td>
<td>2 h in each 3 perpendicular directions</td>
</tr>
<tr>
<td>Mechanical shock</td>
<td>IEC 68-2-27 Ea</td>
<td>Peak acceleration</td>
<td>100 g</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Duration</td>
<td>6 ms</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Pulse shape</td>
<td>Half sine</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Directions</td>
<td>6</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Number of pulses</td>
<td>18 (3 + 3 in each perpendicular direction)</td>
</tr>
<tr>
<td>Change of temperature (Temperature cycling)</td>
<td>IEC 60068-2-14 Na</td>
<td>Temperature range</td>
<td>-40 to +100°C</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Number of cycles</td>
<td>300</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Dwell time</td>
<td>30 min</td>
</tr>
<tr>
<td>Robustness of terminations</td>
<td>IEC 68-2-21 Ue1</td>
<td>Surface mount products</td>
<td>All leads</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Through hole mount products</td>
<td>All leads</td>
</tr>
<tr>
<td>Solderability</td>
<td>IEC 68-2-58 Te1</td>
<td>Temperature, SnPb Eutectic</td>
<td>215 ±5°C</td>
</tr>
<tr>
<td>Surface mount version</td>
<td></td>
<td>Temperature, Pb free Preconditioning</td>
<td>245 ±5°C</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Temperature, Pb free</td>
<td>240 h in 85°C/85%RH</td>
</tr>
<tr>
<td>Solderability</td>
<td>IEC 68-2-58 Te1</td>
<td>Temperature, Pb free Solder immersion time Preconditioning</td>
<td>260 ±5°C</td>
</tr>
<tr>
<td>Hole mount version</td>
<td></td>
<td>5 ±0.5 s</td>
<td>Steam ageing 8 h±15 minutes</td>
</tr>
<tr>
<td>Damp heat</td>
<td>IEC 60068-2-67 Cy with bias</td>
<td>Temperature Humidity</td>
<td>300 hours</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Duration</td>
<td>Reflowed 3X according to IPC/JEDEC J-STD-020C MSL3 at 260°C</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Preconditioning</td>
<td></td>
</tr>
<tr>
<td>Moisture reflow sensitivity classification</td>
<td>J-STD-020C</td>
<td>SnPb Eutectic Pb free</td>
<td>MSL 1, peak reflow at 225°C MSL 3, peak reflow at 260°C</td>
</tr>
<tr>
<td>Immersion in cleaning solvents</td>
<td>IEC 68-2-45 XA Method 2</td>
<td>Water, Isopropyl alcohol Glycol ether</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>Preconditioning</td>
<td>+55 ±5°C +35 ±5°C</td>
</tr>
<tr>
<td>Cold (in operation)</td>
<td>IEC 68-2-1 Aa</td>
<td>Temperature Ta</td>
<td>-40°C</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Duration</td>
<td>72 h</td>
</tr>
</tbody>
</table>